INTERNATIONAL STANDARD



First edition 2015-11-01

Identification cards — ICC-managed devices —

Part 2: Physical characteristics and test methods for cards with devices

iTeh STCartes d'identification P Dispositifs contrôlés par carte à circuit intégré (ICC) — (standards iteh ai) Partie 2: Caractéristiques physiques et méthodes d'essai des cartes avec les dispositifs ISO/IEC 18328-2:2015 https://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0bb561972dc77f/iso-iec-18328-2:2015



Reference number ISO/IEC 18328-2:2015(E)

iTeh STANDARD PREVIEW (standards.iteh.ai)

<u>ISO/IEC 18328-2:2015</u> https://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0bb561972dc77ffiso-iec-18328-2-2015



© ISO/IEC 2015, Published in Switzerland

All rights reserved. Unless otherwise specified, no part of this publication may be reproduced or utilized otherwise in any form or by any means, electronic or mechanical, including photocopying, or posting on the internet or an intranet, without prior written permission. Permission can be requested from either ISO at the address below or ISO's member body in the country of the requester.

ISO copyright office Ch. de Blandonnet 8 • CP 401 CH-1214 Vernier, Geneva, Switzerland Tel. +41 22 749 01 11 Fax +41 22 749 09 47 copyright@iso.org www.iso.org

Page

Contents

Forew	ord		iv
1	Scope		
2	Normative references		
3	Term	s and definitions	
4	Abbro	eviated terms	2
5	Requ 5.1 5.2 5.3	irementsGeneral requirements5.1.1Integrated circuit cards (ICCs)5.1.2ICCs with contacts5.1.3Contactless ICCsRequirements for ICCs containing displays5.2.1General requirements5.2.2Requirements for matrix displays5.2.3Requirements for cards containing biometric capture devices	2 2 2 2 2 2 2 2 3 3 3 3 3 3 3 3 3 3 3 3
Annex	A (inf	ormative) ID-T size card	4
Annex	B (inf	ormative) Coexistence of new devices with existing technologies	6
Annex Biblio	c (info graphy	ormative) Display and input element technologies	

ISO/IEC 18328-2:2015 https://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0bb561972dc77f/iso-iec-18328-2-2015

Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work. In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC JTC 1.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of document should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO and IEC shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received (see www.iso.org/patents).

Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation on the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the WTO principles in the Technical Barriers to Trade (TBT) see the following URL: Foreword - Supplementary information

The committee responsible for this document is ISO/IEC JTC 1, *Information technology*, SC 17, *Cards and ISO/IEC 18328-2:2015* https://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0b-

ISO/IEC 18328 consists of the following parts; 7 under the general title Identification cards — ICCmanaged devices:

- Part 1: General framework
- Part 2: Physical characteristics and test methods for cards with devices
- Part 3: Organization, security and commands for interchange

Identification cards — ICC-managed devices —

Part 2: Physical characteristics and test methods for cards with devices

1 Scope

This part of ISO/IEC 18328 defines physical characteristics and test methods for cards with devices, including but not limited to power supplying devices, displays, sensors, microphones, loudspeakers, buttons or keypads. This part of ISO/IEC 18328 also covers aspects of coexistence of technologies of devices on the card and other machine readable card technologies.

Additional requirements related to biometric capture devices are defined in ISO/IEC 17839-2. Such requirements may be applied in addition to the ones defined in this part of ISO/IEC 18328.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO/IEC 7810, Identification cards — Physical characteristics

https://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0b-ISO/IEC 7816-1, Identification cards - Integrated circuit cards - Part 1: Cards with contacts — Physical characteristics

ISO/IEC 14443-1, Identification cards — Contactless integrated circuit cards — Proximity cards — Part 1: Physical characteristics

ISO/IEC 17839-2¹⁾, Identification cards — Biometric system on card — Part 2: Physical characteristics

ISO/IEC 18328-1¹), Identification cards — ICC-managed devices — Part 1: General framework

3 Terms and definitions

For the purposes of this document, the terms and definitions given in ISO/IEC 7810, ISO/IEC 18328-1 and the following apply.

3.1

active display area

area of the display that has active dots or segments

Note 1 to entry: The *total display area* typically extends beyond the active display area.

3.2

zone 1

<zones of a display> total display area excluding the active display area

¹⁾ To be published.

3.2.2

zone 2

<zones of a display> active display area

4 Abbreviated terms

- LED Light-emitting diode
- OLED Organic light-emitting diode

5 Requirements

5.1 General requirements

5.1.1 Integrated circuit cards (ICCs)

ICCs with integrated devices shall comply with the requirements defined for ID-1 cards as specified in ISO/IEC 7810, in particular regarding the following:

(standards.iteh.ai)

- card dimensions and tolerances;
- bending stiffness;
- peel strength;
 iTeh STANDARD PREVIEW
- overall card warpage;
- card dimensional stability and warpage with temperature and humidity;
- resistance to chemical stops://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0b-

b561972dc77f/iso-iec-18328-2-2015

— opacity.

Guidance about the co-existence of different technologies on such cards is given in <u>Annex B</u>. A description of different display and input element technologies is provided in <u>Annex C</u>.

5.1.2 ICCs with contacts

ICCs with contacts shall in addition meet the requirements specified in ISO/IEC 7816-1 regarding the following:

- mechanical strength;
- electrical resistance of contacts;
- electromagnetic interference.

5.1.3 Contactless ICCs

Contactless ICCs shall in addition meet the requirement specified in ISO/IEC 14443-1 regarding the antenna location.

5.2 Requirements for ICCs containing displays

5.2.1 General requirements

The following requirements apply to ICCs containing electronic displays.

NOTE 1 Today, there is no stable state-of-the-art regarding the technology of card displays or the correlation between legibility of displays and their functional performance. The requirements described in this part of ISO/IEC 18328 should be considered as preliminary. The detailed requirements for ICCs containing electronic displays depend on the specific use-case.

ICCs containing electronic displays meet the test requirements if the optical contrast is not less than a defined percentage of the optical contrast immediately before the test, as specified by the application.

NOTE 2 Readability and contrast: An observer's ability to perceive the information from an electronic display depends on two major factors. These are (a) size and font of the displayed information in relationship to the viewing position and (b) the optical contrast of the displayed information to the surrounding environment. Optical contrast is the comparison of the brightness or sterance of the display to the brightness of the surrounding environment. High readability results by optimizing specific contrast ratios.

5.2.2 Requirements for matrix displays

In addition to the test requirements in 5.2.1, for ICCs with matrix displays, it is required that not less than a defined percentage of all pixels remain functional after the test, as specified by the application.

5.2.3 Requirements for segmented displays RD PREVIEW

In addition to the test requirements in **5121**; for **ICCs with** segmented displays, no segment failure (dead segment) is allowed, i.e. after the test all segments should be working in both directions from white to black and from black to white.

- Dead spots in zone 1 (i.e. outside the active display area) can be accepted.
- Dead spots in zone 2 (i.e. within the active display area) can be accepted if their size and number are lower than values specified by the application.

5.3 Requirements for cards containing biometric capture devices

ICCs that embed a biometric capture device may be required to conform to requirements in ISO/IEC 17839-2, in addition to the mandatory requirements of this part of ISO/IEC 18328. <u>Annex A</u> gives an example of an alternative card size.

Annex A (informative)

ID-T size card

A.1 General

ID-T size cards are the same length and width as a normal ID-1 size card but are thicker.

The additional thickness is required for an interim period of time to accommodate electronic card components used for biometric capture devices. This card format is intended to accommodate certain restrictions of current manufacturing technology. The need for this Annex will be reviewed as part of the next revision of this part of ISO/IEC 18328.

ID-T size cards are not intended for use with any type of insertion reader typically used with an ID-1 size card such as for magnetic stripe or ICC contact readers. This Annex specifies physical characteristics for a thicker card if it is used.

A.2 Conformance

iTeh STANDARD PREVIEW

ID-T size cards are made from similar materials as ID-1 size cards and meet all requirements given in ISO/IEC 7810 for ID-1 size cards except as noted in this Annex 1.21

NOTE Dynamic bending stress and dynamic torsional stress in ISO/IEC 7810 apply only to ID-1 size cards.

https://standards.iteh.ai/catalog/standards/sist/29ec7e6f-3ac4-4169-ba0bitions b561972dc77ffiso-iec-18328-2-2015

A.3 Terms and definitions

A.3.1

ID-T

nominally 85,60 mm (3,370 in) wide by 53,98 mm (2,125 in) high by 2,5 mm (0,098 in) thick

A.4 Dimensions

- Dimensions a, b and c (see Figure A.1) shall be as defined for an ID-1 size card.
- Dimension d shall be $2,5 \pm 0,2$ mm.
- Dimension e (optional radius all around the perimeter of the card).

NOTE The addition of an optional $0,3 \pm 0,1$ mm radius, e, is recommended. Adding such a radius will make it easier to slide this thicker card into a wallet card holder.



Key

- 1 top reference edge
- 2 left edge

iTeh STANDARD PREVIEW (standards.iteh.ai)

A.5 Bending stiffness

The bending stiffness of the ID-T size card shall be such that deformations in normal use (bends not creases) can be removed by the recording of printing device without impairing the function of the card. The deformation which occurs when the card is subjected to the test load as described in ISO/IEC 10373-1 shall be 4 mm (0,157 in) maximum. The card shall return to within 0,3 mm (0,012 in) of its original flat condition within one minute after the load is removed.

A.6 Overall card warpage

The maximum distance from a flat rigid plate to any portion of the convex surface of an ID-T size card shall not be greater than 3,2 mm (0,126 in) including the card thickness.